MUN5111DW1T1 Series

Preferred Devices

Dual Bias Resistor Transistors

PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base−emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the MUN5111DW1T1 series, two BRT devices are housed in the SOT−363 package which is ideal for low−power surface mount applications where board space is at a premium.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Pb−Free Packages are Available

MAXIMUM RATINGS

(T_A = 25°C unless otherwise noted, common for Q_1 and Q_2)

Rating	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	−50	Vdc
Collector-Emitter Voltage	V_{CEO}	−50	Vdc
Collector Current	I_C	−100	mAdc

THERMAL CHARACTERISTICS

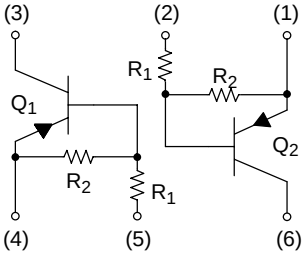
Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D	187 (Note 1) 256 (Note 2) 1.5 (Note 1) 2.0 (Note 2)	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	670 (Note 1) 490 (Note 2)	°C/W
Characteristic (Both Junctions Heated)	**Symbol**	**Max**	**Unit**
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D	250 (Note 1) 385 (Note 2) 2.0 (Note 1) 3.0 (Note 2)	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	493 (Note 1) 325 (Note 2)	°C/W
Thermal Resistance, Junction-to-Lead	$R_{\theta JL}$	188 (Note 1) 208 (Note 2)	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR−4 @ Minimum Pad
2. FR−4 @ 1.0 x 1.0 inch Pad

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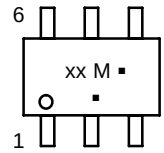
http://onsemi.com





SOT−363
CASE 419B
STYLE 1

MARKING DIAGRAM



xx = Device Code (Refer to page 2)
M = Date Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the table on page 2 of this data sheet.

DEVICE MARKING INFORMATION

See specific marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

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DEVICE MARKING AND RESISTOR VALUES

Device	Package	Marking	R1 (K)	R2 (K)	Shipping†
MUN5111DW1T1	SOT−363	0A	10	10	3000/Tape & Reel
MUN5111DW1T1G	SOT−363 (Pb−Free)	0A	10	10	3000/Tape & Reel
MUN5112DW1T1	SOT−363	0B	22	22	3000/Tape & Reel
MUN5112DW1T1G	SOT−363 (Pb−Free)	0B	22	22	3000/Tape & Reel
MUN5113DW1T1	SOT−363	0C	47	47	3000/Tape & Reel
MUN5113DW1T1G	SOT−363 (Pb−Free)	0C	47	47	3000/Tape & Reel
MUN5114DW1T1	SOT−363	0D	10	47	3000/Tape & Reel
MUN5114DW1T1G	SOT−363 (Pb−Free)	0D	10	47	3000/Tape & Reel
MUN5115DW1T1	SOT−363	0E	10	∞	3000/Tape & Reel
MUN5115DW1T1G	SOT−363 (Pb−Free)	0E	10	∞	3000/Tape & Reel
MUN5116DW1T1	SOT−363	0F	4.7	∞	3000/Tape & Reel
MUN5116DW1T1G	SOT−363 (Pb−Free)	0F	4.7	∞	3000/Tape & Reel
MUN5130DW1T1	SOT−363	0G	1.0	1.0	3000/Tape & Reel
MUN5130DW1T1G	SOT−363 (Pb−Free)	0G	1.0	1.0	3000/Tape & Reel
MUN5131DW1T1	SOT−363	0H	2.2	2.2	3000/Tape & Reel
MUN5131DW1T1G	SOT−363 (Pb−Free)	0H	2.2	2.2	3000/Tape & Reel
MUN5132DW1T1	SOT−363	0J	4.7	4.7	3000/Tape & Reel
MUN5132DW1T1G	SOT−363 (Pb−Free)	0J	4.7	4.7	3000/Tape & Reel
MUN5133DW1T1	SOT−363	0K	4.7	47	3000/Tape & Reel
MUN5133DW1T1G	SOT−363 (Pb−Free)	0K	4.7	47	3000/Tape & Reel
MUN5134DW1T1	SOT−363	0L	22	47	3000/Tape & Reel
MUN5134DW1T1G	SOT−363 (Pb−Free)	0L	22	47	3000/Tape & Reel
MUN5135DW1T1	SOT−363	0M	2.2	47	3000/Tape & Reel
MUN5135DW1T1G	SOT−363 (Pb−Free)	0M	2.2	47	3000/Tape & Reel
MUN5136DW1T1	SOT−363	0N	100	100	3000/Tape & Reel
MUN5136DW1T1G	SOT−363 (Pb−Free)	0N	100	100	3000/Tape & Reel
MUN5137DW1T1	SOT−363	0P	47	22	3000/Tape & Reel
MUN5137DW1T1G	SOT−363 (Pb−Free)	0P	47	22	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, common for Q_1 and Q_2)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector-Base Cutoff Current (V_{CB} = −50 V, I_E = 0)		I_{CBO}	−	−	−100	nAdc
Collector-Emitter Cutoff Current (V_{CE} = −50 V, I_B = 0)		I_{CEO}	−	−	−500	nAdc
Emitter-Base Cutoff Current	MUN5111DW1T1	I_{EBO}	−	−	−0.5	mAdc
(V_{EB} = −6.0 V, I_C = 0)	MUN5112DW1T1		−	−	−0.2	
	MUN5113DW1T1		−	−	−0.1	
	MUN5114DW1T1		−	−	−0.2	
	MUN5115DW1T1		−	−	−0.9	
	MUN5116DW1T1		−	−	−1.9	
	MUN5130DW1T1		−	−	−4.3	
	MUN5131DW1T1		−	−	−2.3	
	MUN5132DW1T1		−	−	−1.5	
	MUN5133DW1T1		−	−	−0.18	
	MUN5134DW1T1		−	−	−0.13	
	MUN5135DW1T1		−	−	−0.2	
	MUN5136DW1T1		−	−	−0.05	
	MUN5137DW1T1		−	−	−0.13	
Collector-Base Breakdown Voltage (I_C = −10 μA, I_E = 0)		$V_{(BR)CBO}$	−50	−	−	Vdc
Collector-Emitter Breakdown Voltage (Note 3) (I_C = −2.0 mA, I_B = 0)		$V_{(BR)CEO}$	−50	−	−	Vdc
ON CHARACTERISTICS (Note 3)						
Collector-Emitter Saturation Voltage (I_C = −10 mA, I_E = −0.3 mA)		$V_{CE(sat)}$	−	−	−0.25	Vdc
(I_C = −10 mA, I_B = −5 mA) MUN5130DW1T1/MUN5131DW1T1						
(I_C = −10 mA, I_B = −1 mA) MUN5115DW1T1/MUN5116DW1T1						
MUN5132DW1T1/MUN5133DW1T1/MUN5134DW1T1						
DC Current Gain	MUN5111DW1T1	h_{FE}	35	60	−	
(V_{CE} = −10 V, I_C = −5.0 mA)	MUN5112DW1T1		60	100	−	
	MUN5113DW1T1		80	140	−	
	MUN5114DW1T1		80	140	−	
	MUN5115DW1T1		160	250	−	
	MUN5116DW1T1		160	250	−	
	MUN5130DW1T1		3.0	5.0	−	
	MUN5131DW1T1		8.0	15	−	
	MUN5132DW1T1		15	27	−	
	MUN5133DW1T1		80	140	−	
	MUN5134DW1T1		80	130	−	
	MUN5135DW1T1		80	140	−	
	MUN5136DW1T1		80	130	−	
	MUN5137DW1T1		80	140	−	
Output Voltage (on)		V_{OL}				Vdc
(V_{CC} = −5.0 V, V_B = −2.5 V, R_L = 1.0 kΩ)	MUN5111DW1T1		−	−	−0.2	
	MUN5112DW1T1		−	−	−0.2	
	MUN5114DW1T1		−	−	−0.2	
	MUN5115DW1T1		−	−	−0.2	
	MUN5116DW1T1		−	−	−0.2	
	MUN5130DW1T1		−	−	−0.2	
	MUN5131DW1T1		−	−	−0.2	
	MUN5132DW1T1		−	−	−0.2	
	MUN5133DW1T1		−	−	−0.2	
	MUN5134DW1T1		−	−	−0.2	
	MUN5135DW1T1		−	−	−0.2	
(V_{CC} = −5.0 V, V_B = −3.5 V, R_L = 1.0 kΩ)	MUN5113DW1T1		−	−	−0.2	
(V_{CC} = −5.0 V, V_B = −5.5 V, R_L = 1.0 kΩ)	MUN5136DW1T1		−	−	−0.2	
(V_{CC} = −5.0 V, V_B = −4.0 V, R_L = 1.0 kΩ)	MUN5137DW1T1		−	−	−0.2	
Output Voltage (off) (V_{CC} = −5.0 V, V_B = −0.5 V, R_L = 1.0 kΩ)		V_{OH}	−4.9	−	−	Vdc
(V_{CC} = −5.0 V, V_B = −0.05 V, R_L = 1.0 kΩ)	MUN5130DW1T1					
(V_{CC} = −5.0 V, V_B = −0.25 V, R_L = 1.0 kΩ)	MUN5115DW1T1					
	MUN5116DW1T1					
	MUN5131DW1T1					
	MUN5133DW1T1					

3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, common for Q_1 and Q_2) (Continued)

Characteristic		Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS (Note 4) (Continued)						
Input Resistor	MUN5111DW1T1	R_1	7.0	10	13	k Ω
	MUN5112DW1T1		15.4	22	28.6	
	MUN5113DW1T1		32.9	47	61.1	
	MUN5114DW1T1		7.0	10	13	
	MUN5115DW1T1		7.0	10	13	
	MUN5116DW1T1		3.3	4.7	6.1	
	MUN5130DW1T1		0.7	1.0	1.3	
	MUN5131DW1T1		1.5	2.2	2.9	
	MUN5132DW1T1		3.3	4.7	6.1	
	MUN5133DW1T1		3.3	4.7	6.1	
	MUN5134DW1T1		15.4	22	28.6	
	MUN5135DW1T1		1.54	2.2	2.86	
	MUN5136DW1T1		70	100	130	
	MUN5137DW1T1		32.9	47	61.1	
Resistor Ratio	MUN5111DW1T1/MUN5112DW1T1/	R_1/R_2				
	MUN5113DW1T1/MUN5136DW1T1		0.8	1.0	1.2	
	MUN5114DW1T1		0.17	0.21	0.25	
	MUN5115DW1T1/MUN5116DW1T1		–	–	–	
	MUN5130DW1T1/MUN5131DW1T1/MUN5132DW1T1		0.8	1.0	1.2	
	MUN5133DW1T1		0.055	0.1	0.185	
	MUN5134DW1T1		0.38	0.47	0.56	
	MUN5135DW1T1		0.038	0.047	0.056	
	MUN5137DW1T1		1.7	2.1	2.6	

4. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

ALL MUN5111DW1T1 SERIES DEVICES

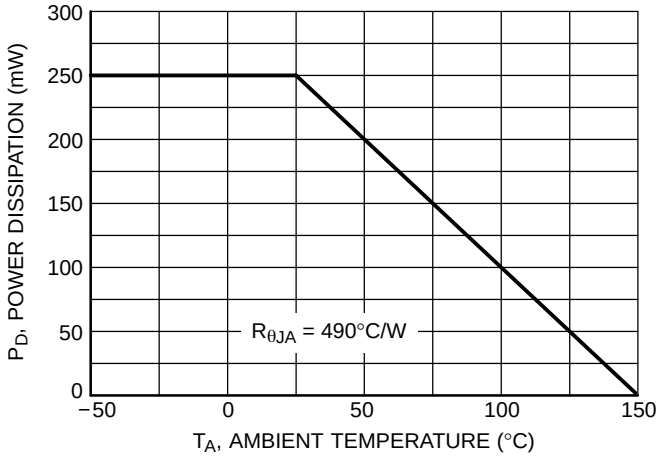


Figure 1. Derating Curve − ALL DEVICES

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5111DW1T1

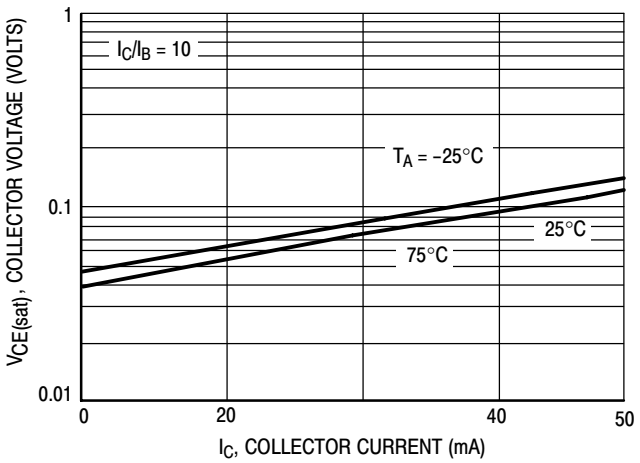


Figure 2. $V_{CE(sat)}$ versus I_C

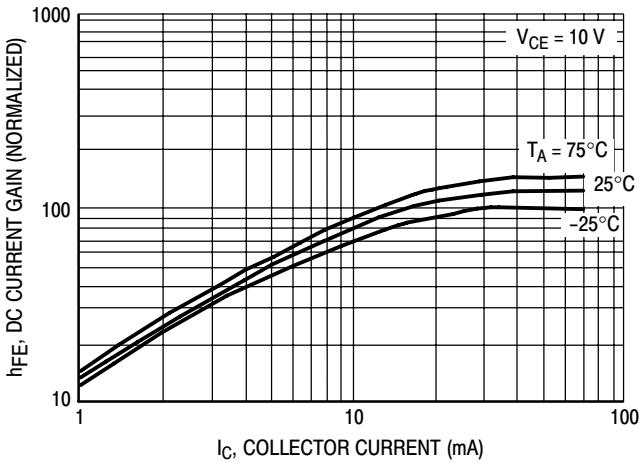


Figure 3. DC Current Gain

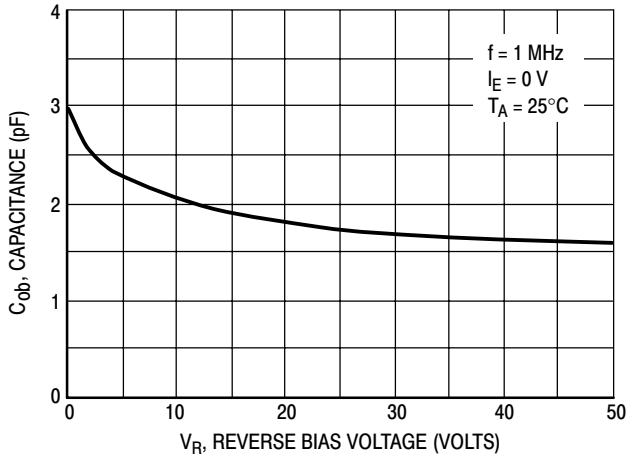


Figure 4. Output Capacitance

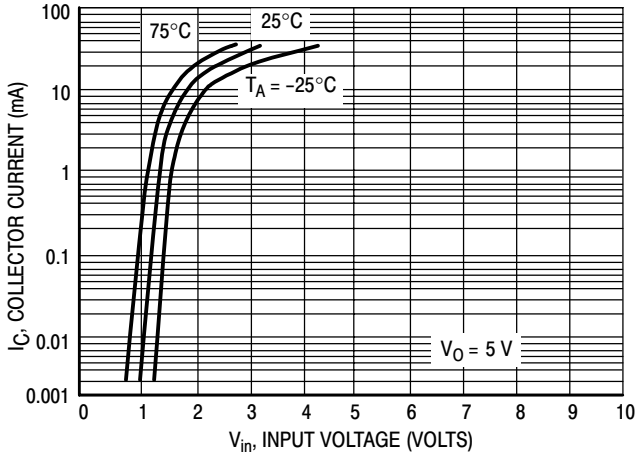


Figure 5. Output Current versus Input Voltage

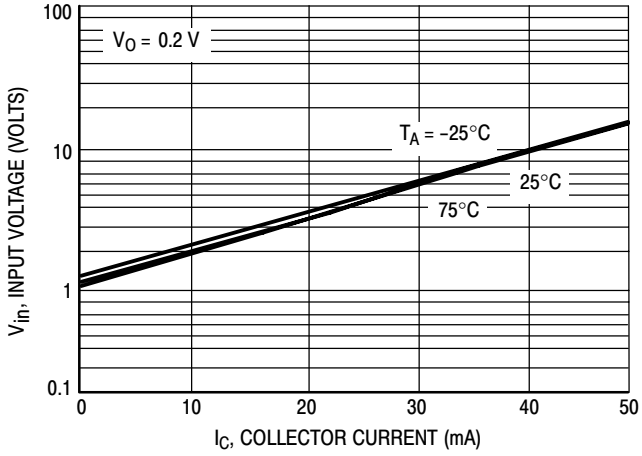


Figure 6. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5112DW1T1

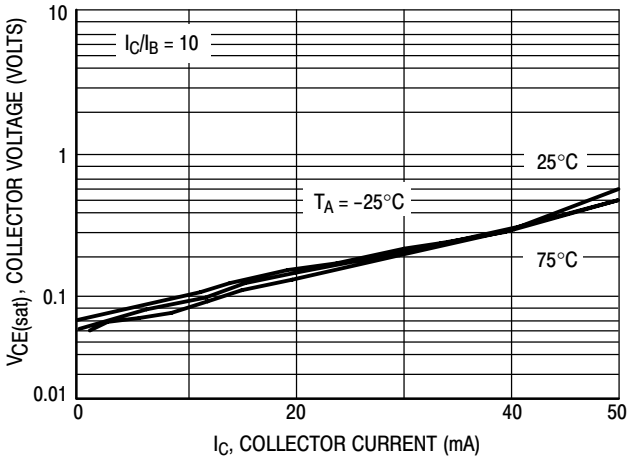


Figure 7. $V_{CE(sat)}$ versus I_C

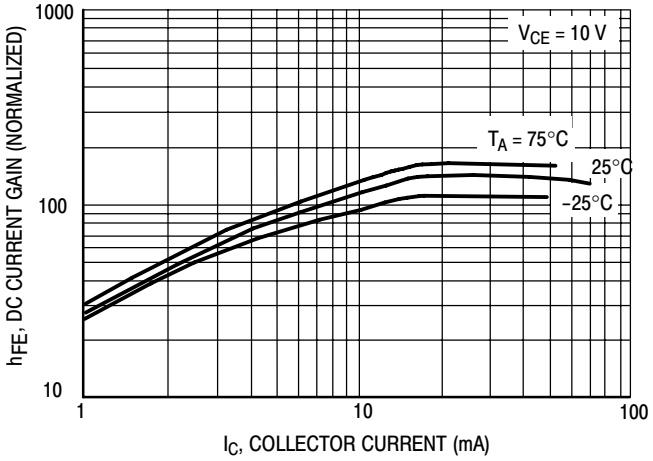


Figure 8. DC Current Gain

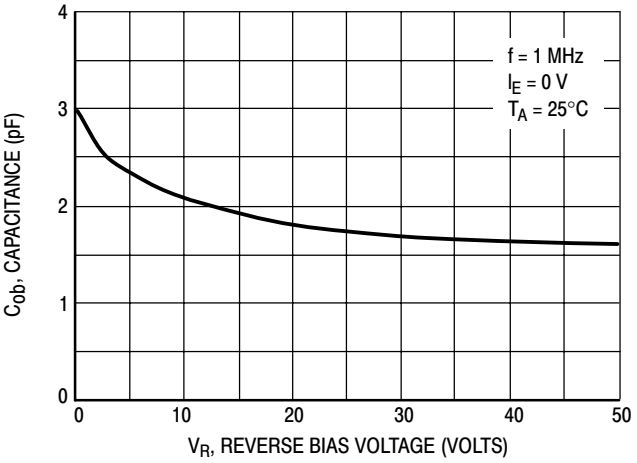


Figure 9. Output Capacitance

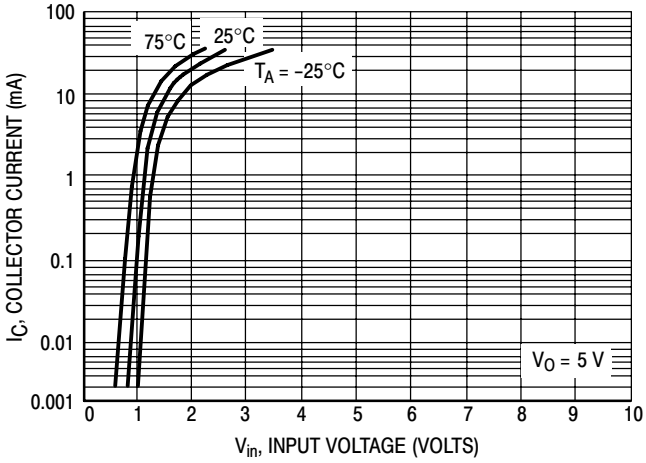


Figure 10. Output Current versus Input Voltage

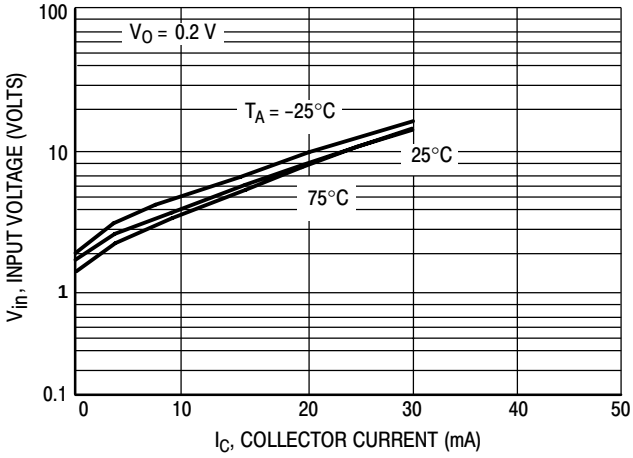


Figure 11. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5113DW1T1

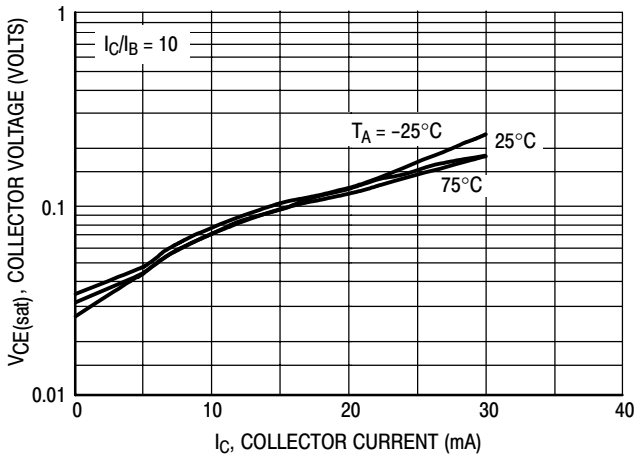


Figure 12. $V_{CE(sat)}$ versus I_C

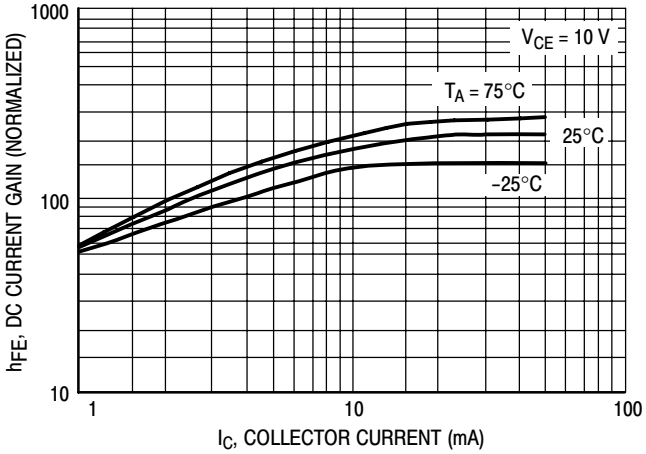


Figure 13. DC Current Gain

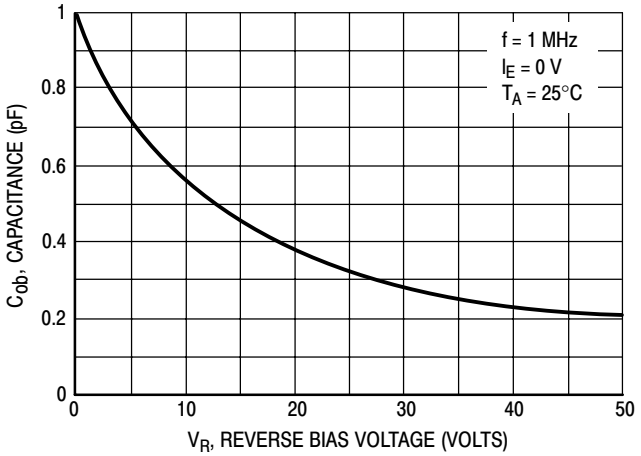


Figure 14. Output Capacitance

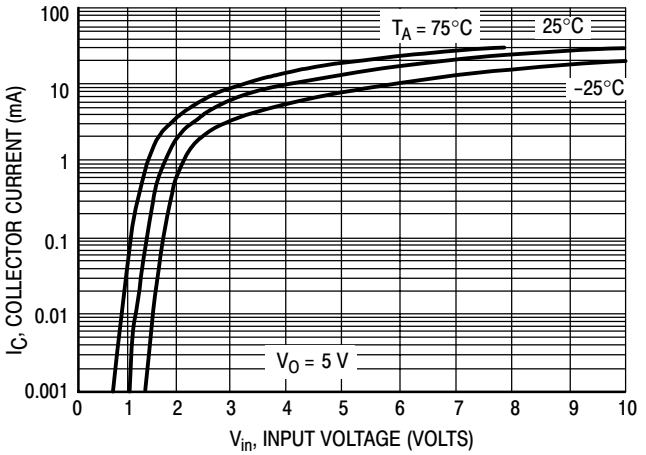


Figure 15. Output Current versus Input Voltage

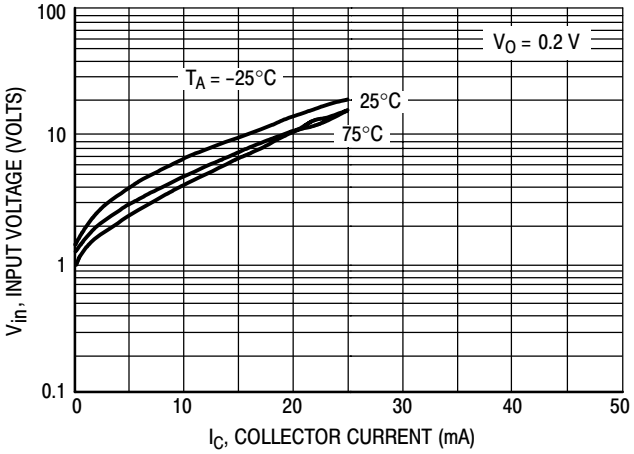


Figure 16. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5114DW1T1

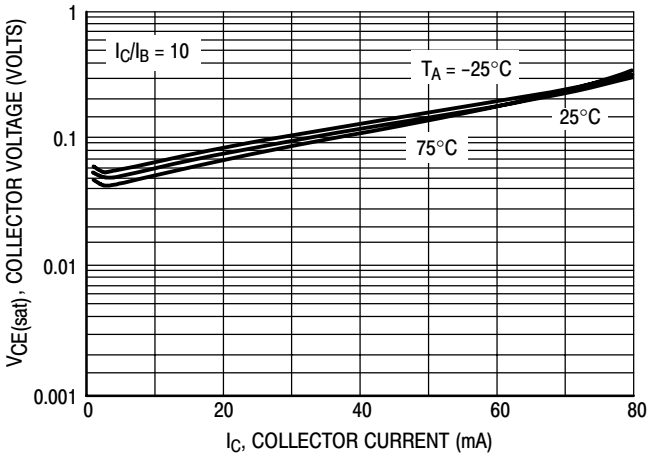


Figure 17. $V_{CE(sat)}$ versus I_C

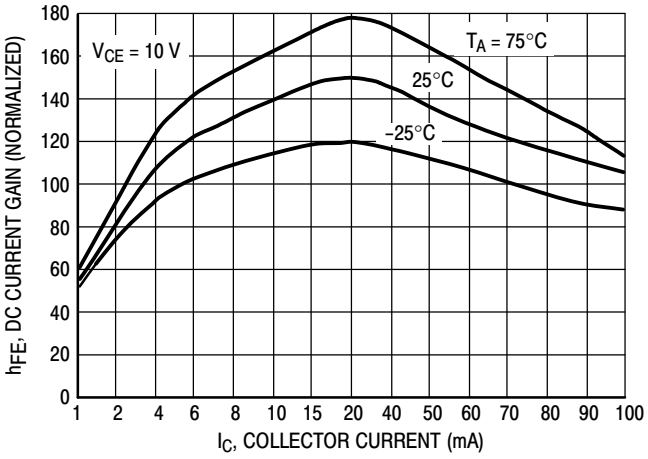


Figure 18. DC Current Gain

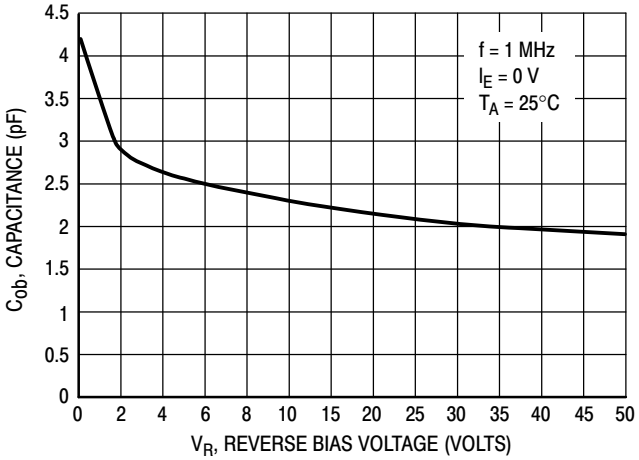


Figure 19. Output Capacitance

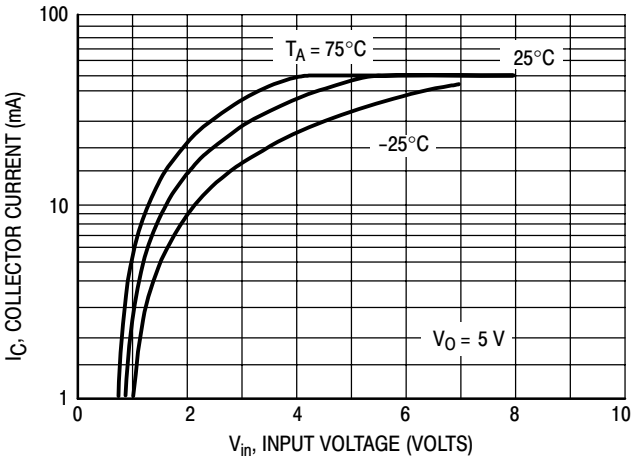


Figure 20. Output Current versus Input Voltage

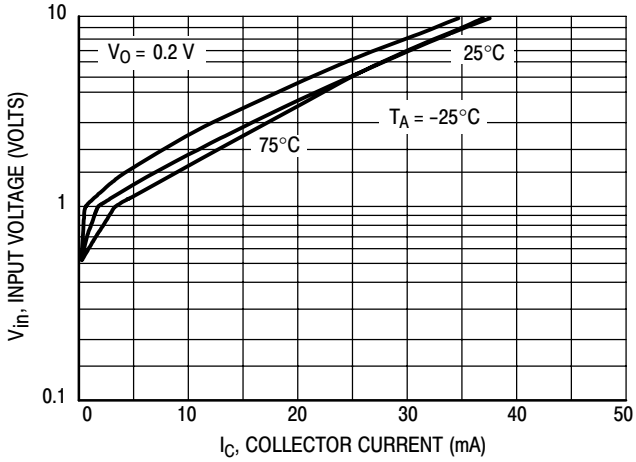


Figure 21. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5115DW1T1

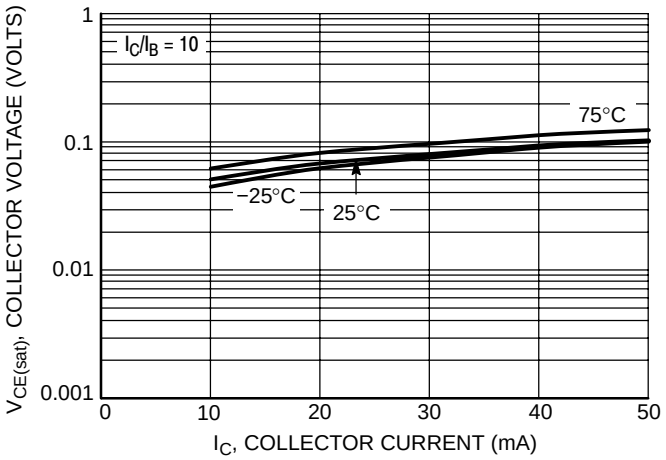


Figure 22. $V_{CE(sat)}$ versus I_C

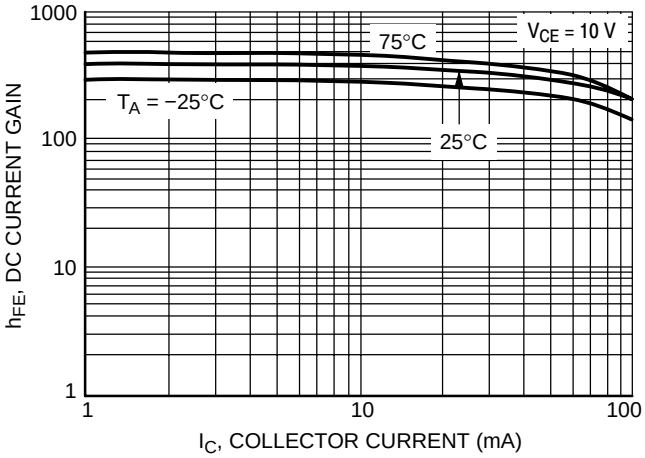


Figure 23. DC Current Gain

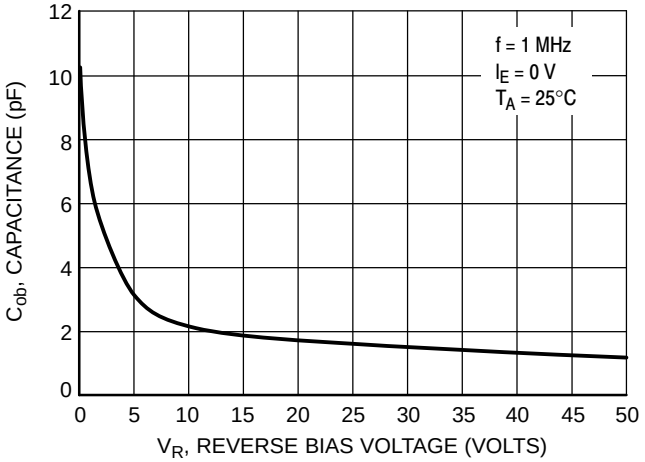


Figure 24. Output Capacitance

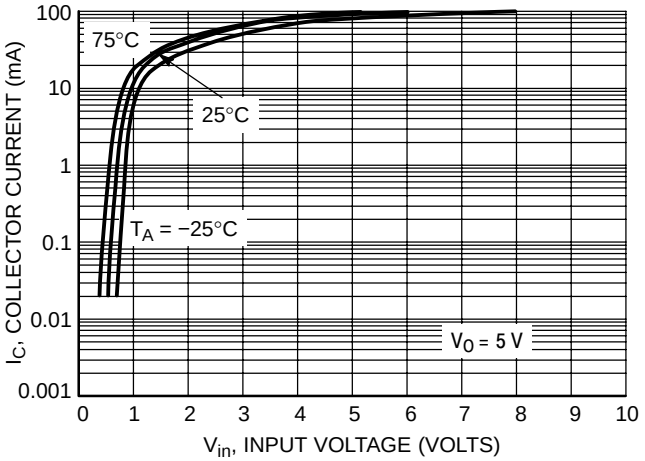


Figure 25. Output Current versus Input Voltage

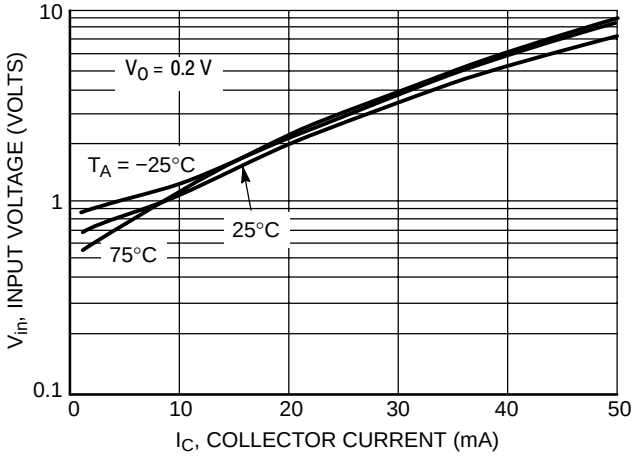


Figure 26. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5116DW1T1

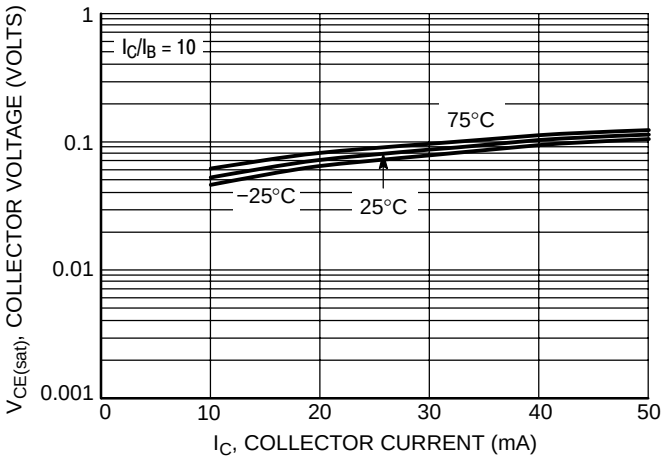


Figure 27. $V_{CE(sat)}$ versus I_C

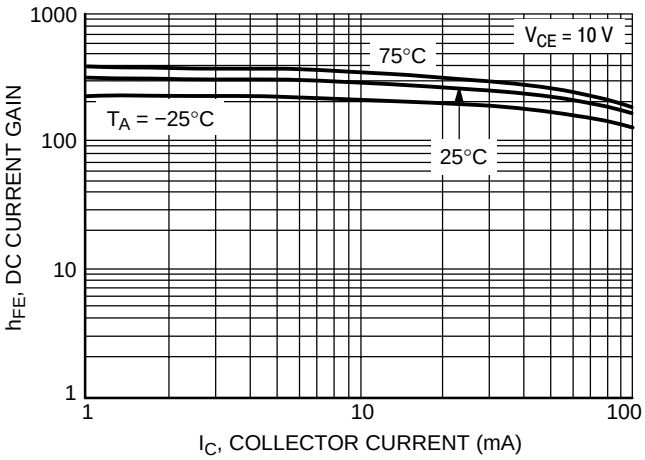


Figure 28. DC Current Gain

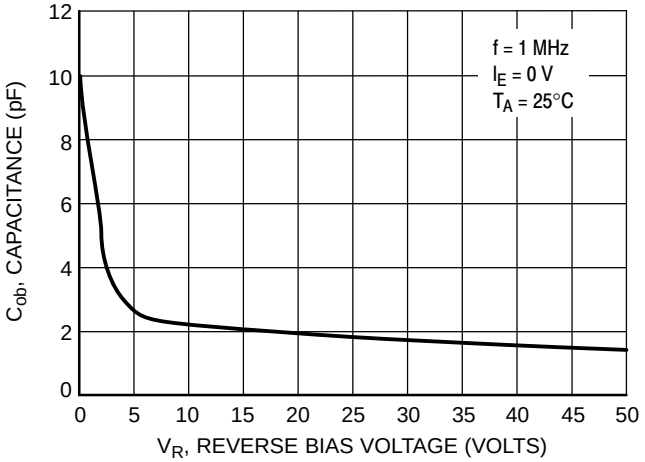


Figure 29. Output Capacitance

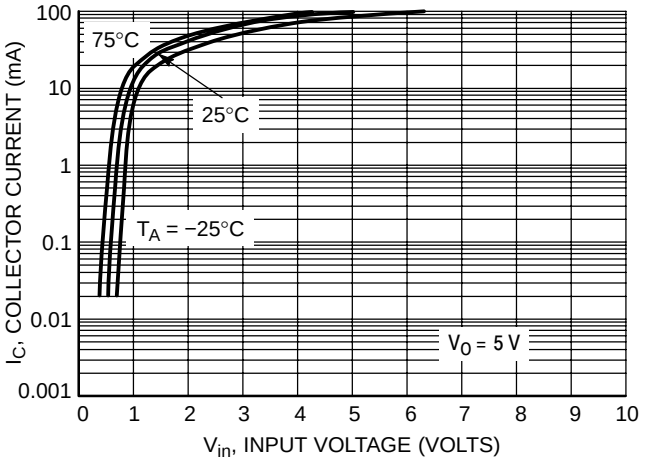


Figure 30. Output Current versus Input Voltage

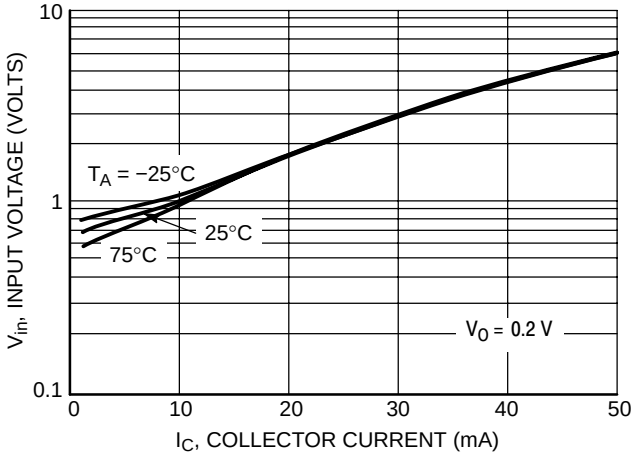


Figure 31. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5130DW1T1

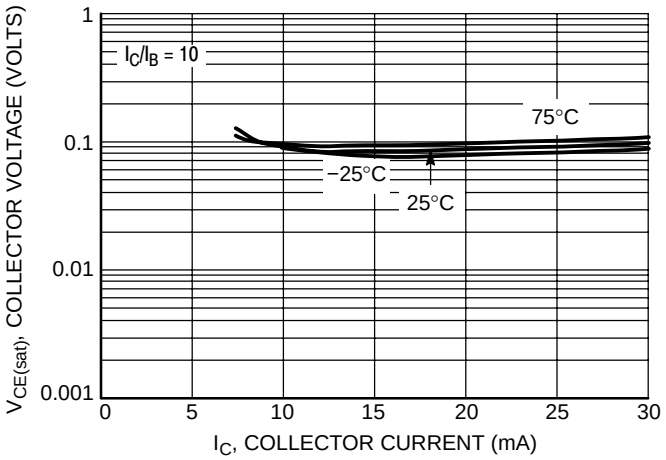


Figure 32. $V_{CE(sat)}$ versus I_C

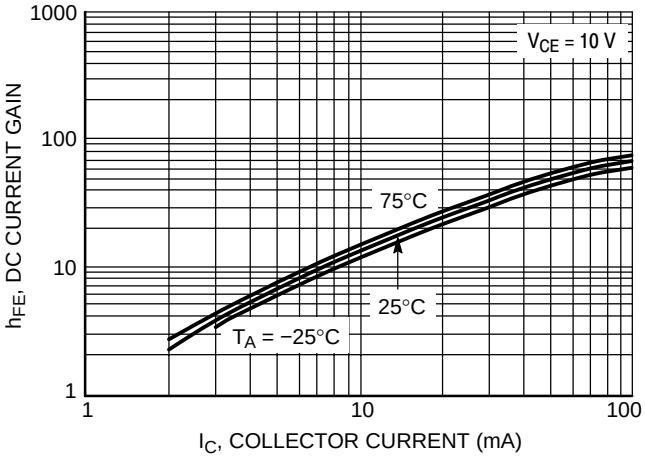


Figure 33. DC Current Gain

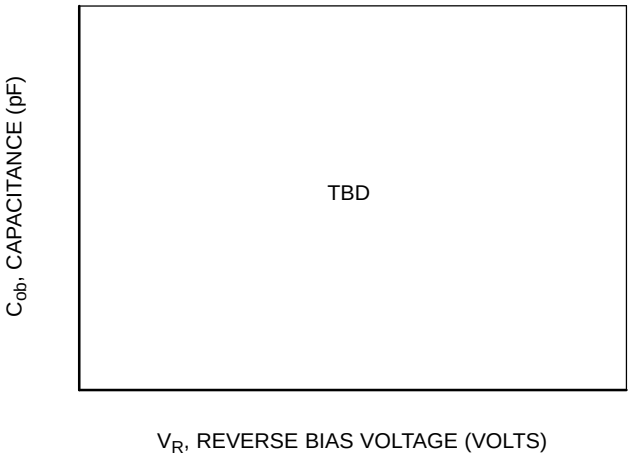


Figure 34. Output Capacitance

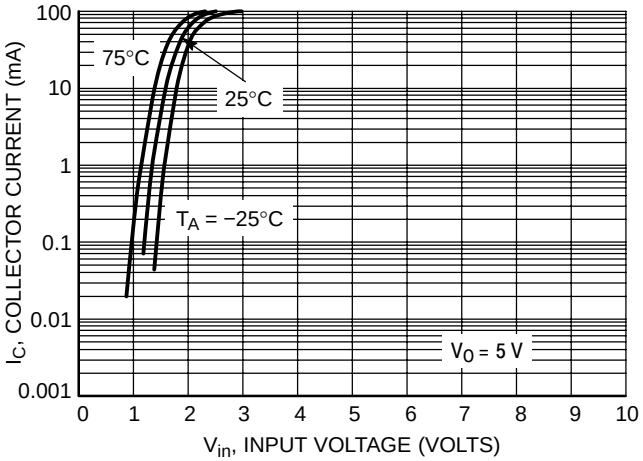


Figure 35. Output Current versus Input Voltage

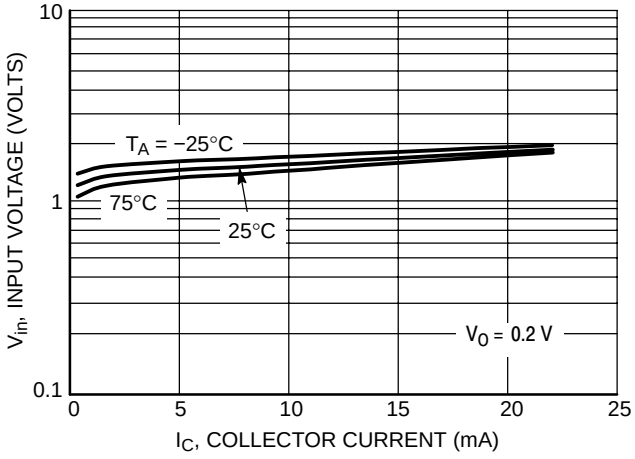


Figure 36. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5131DW1T1

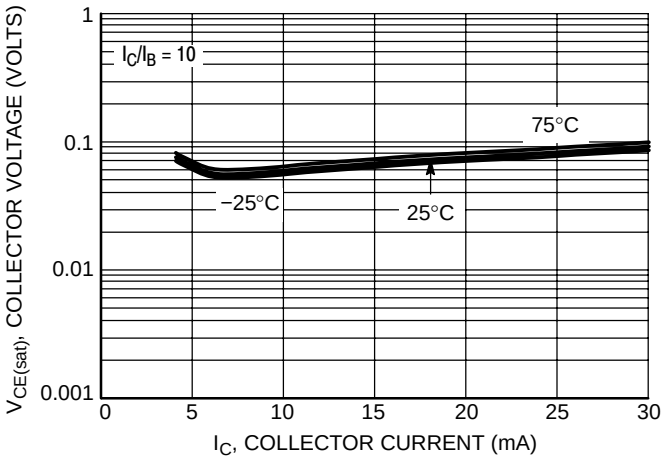


Figure 37. $V_{CE(sat)}$ versus I_C

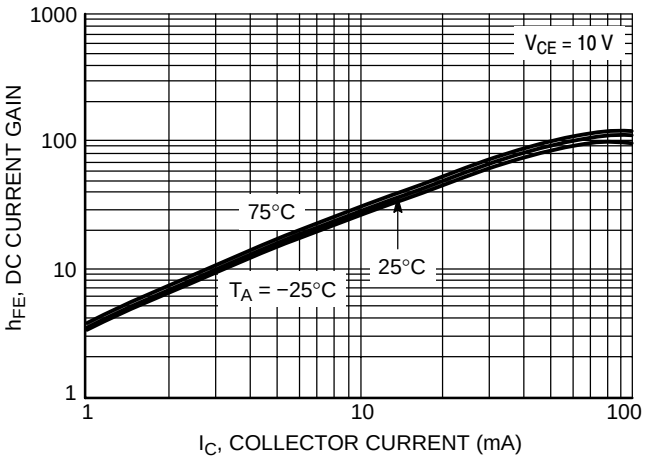


Figure 38. DC Current Gain

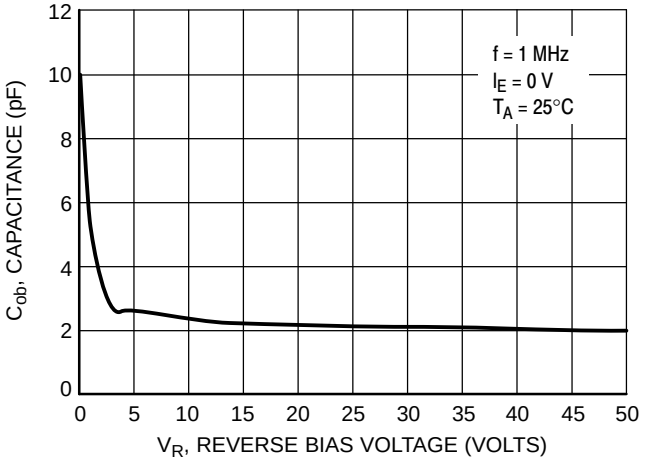


Figure 39. Output Capacitance

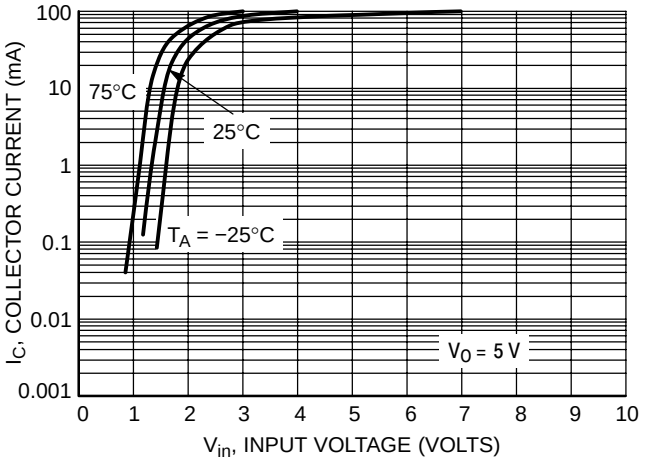


Figure 40. Output Current versus Input Voltage

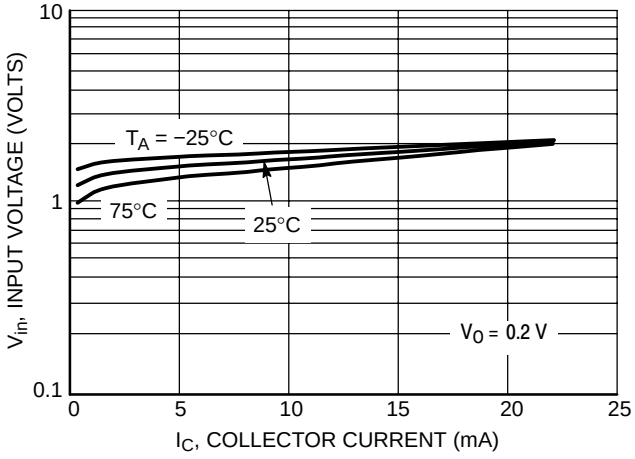


Figure 41. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5132DW1T1

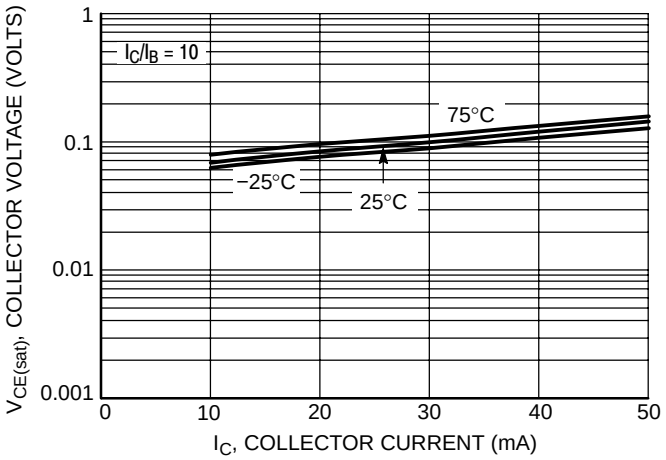


Figure 42. $V_{CE(sat)}$ versus I_C

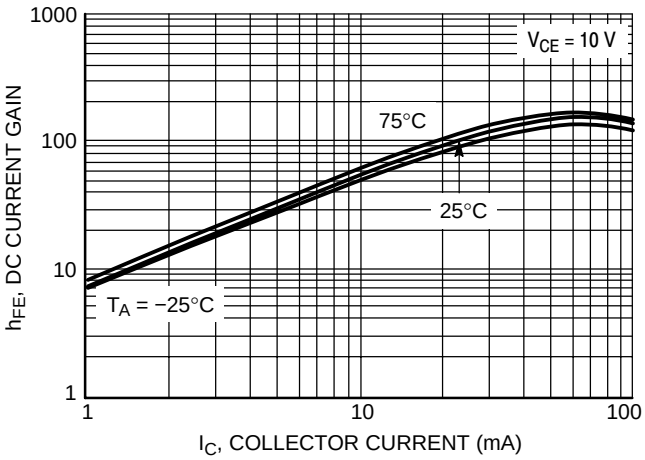


Figure 43. DC Current Gain

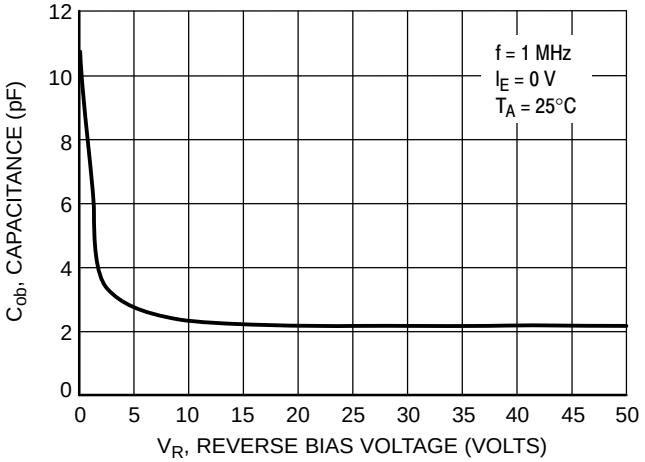


Figure 44. Output Capacitance

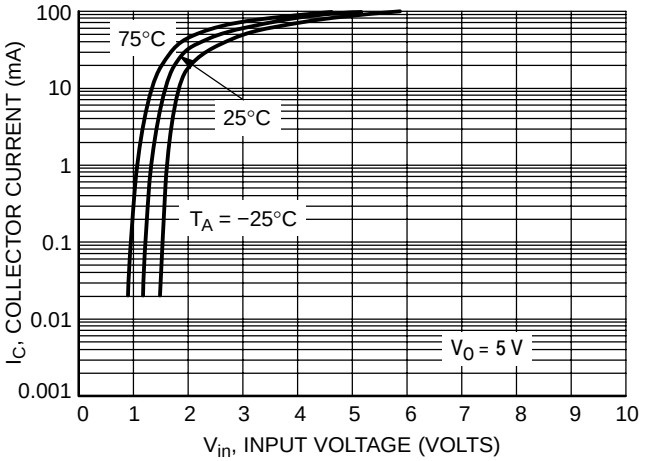


Figure 45. Output Current versus Input Voltage

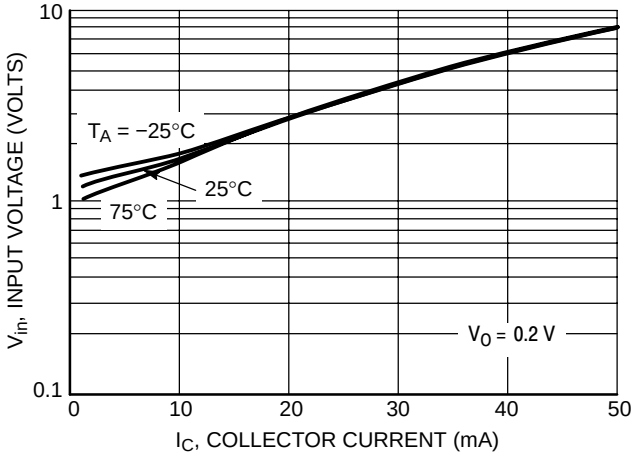


Figure 46. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5133DW1T1

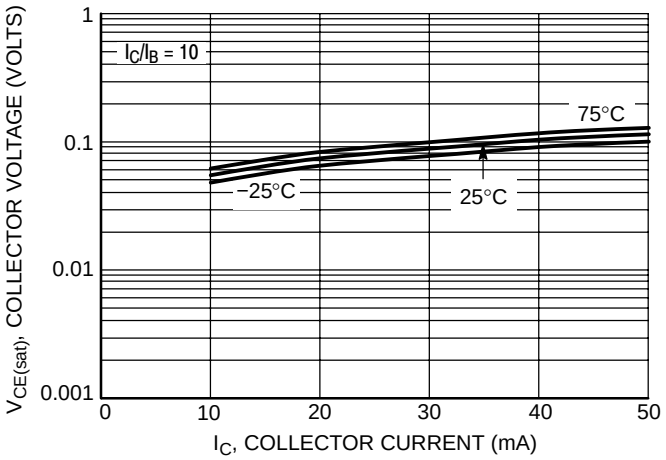


Figure 47. $V_{CE(sat)}$ versus I_C

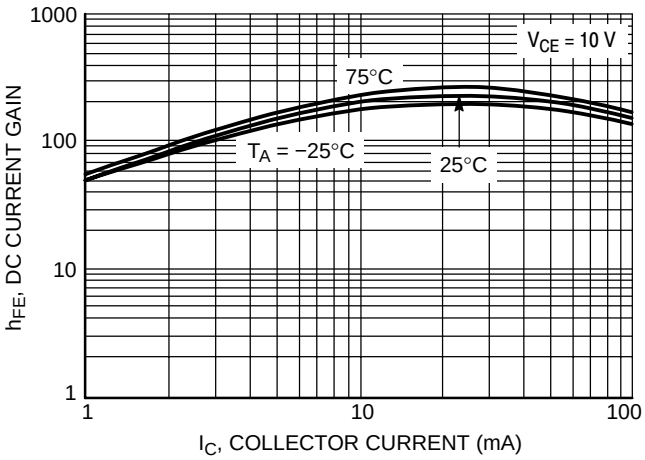


Figure 48. DC Current Gain

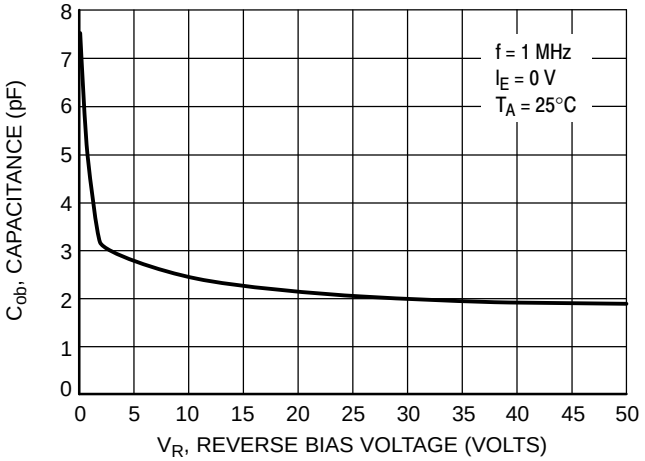


Figure 49. Output Capacitance

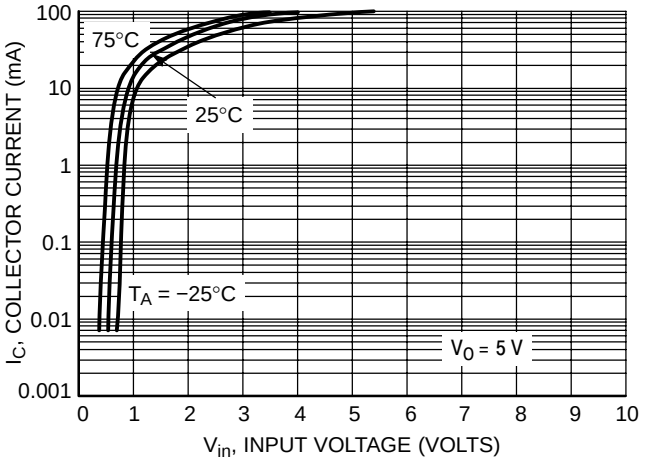


Figure 50. Output Current versus Input Voltage

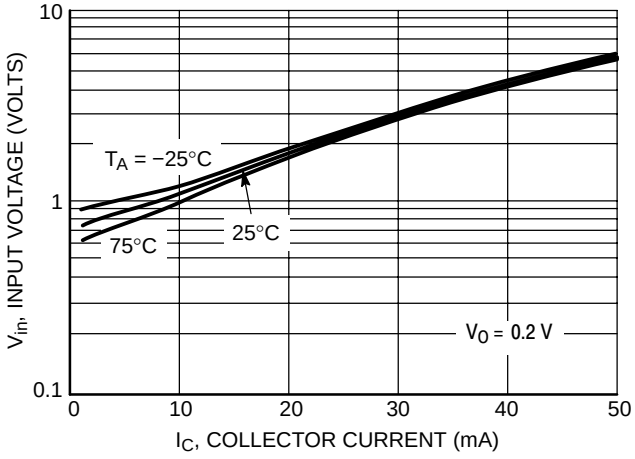


Figure 51. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5134DW1T1

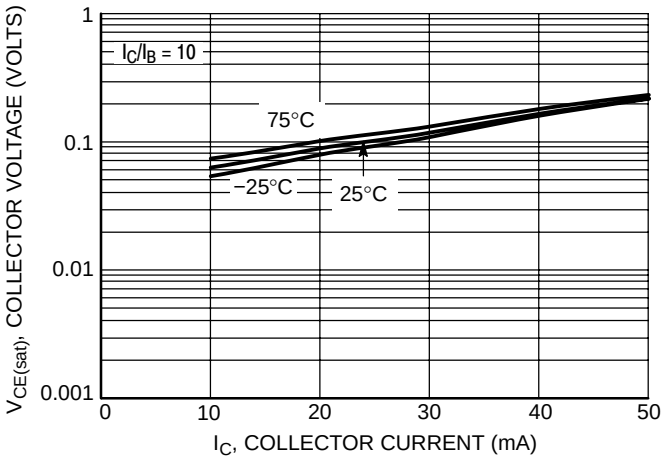


Figure 52. $V_{CE(sat)}$ versus I_C

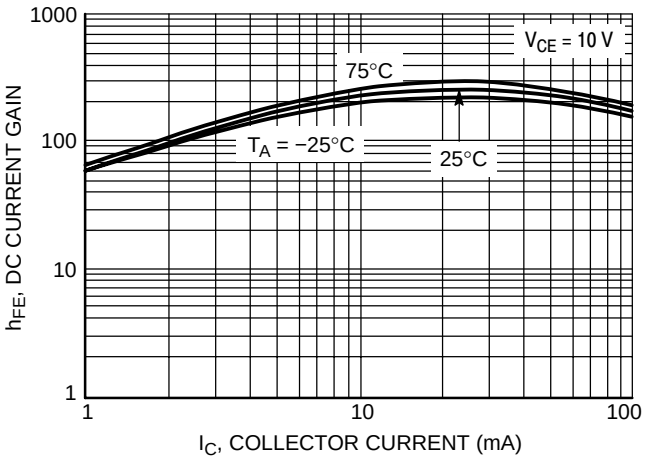


Figure 53. DC Current Gain

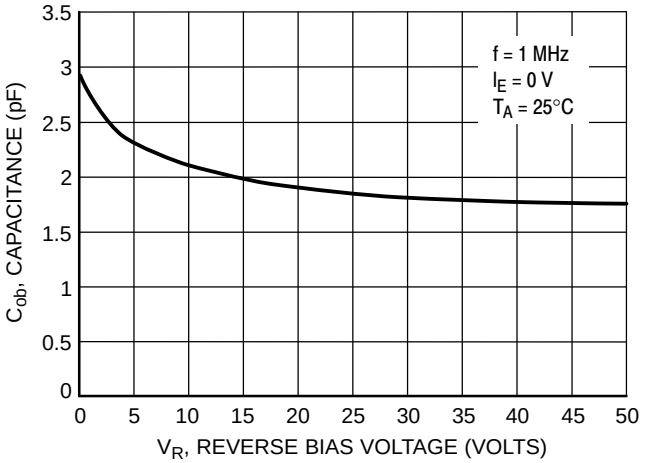


Figure 54. Output Capacitance

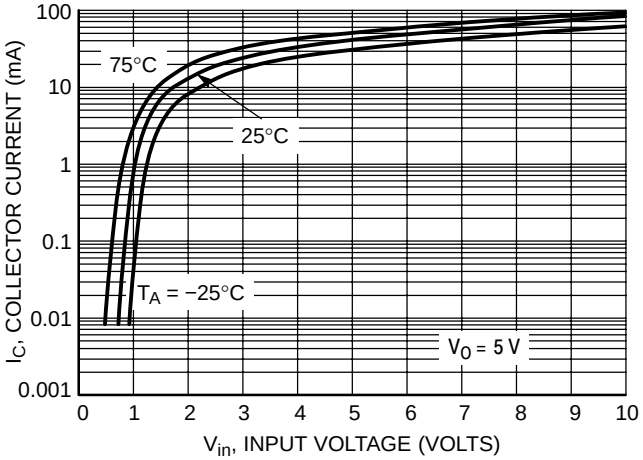


Figure 55. Output Current versus Input Voltage

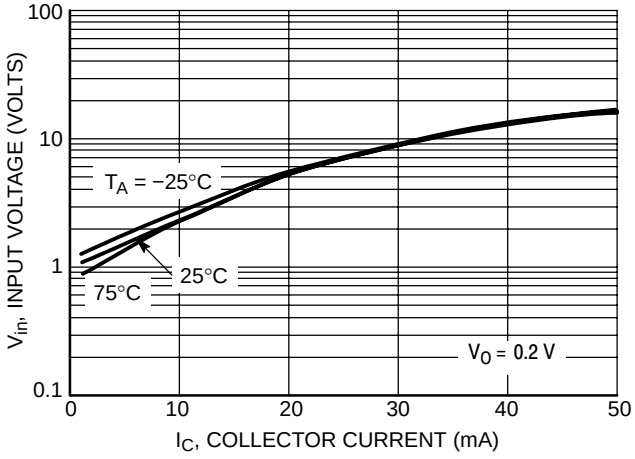


Figure 56. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5135DW1T1

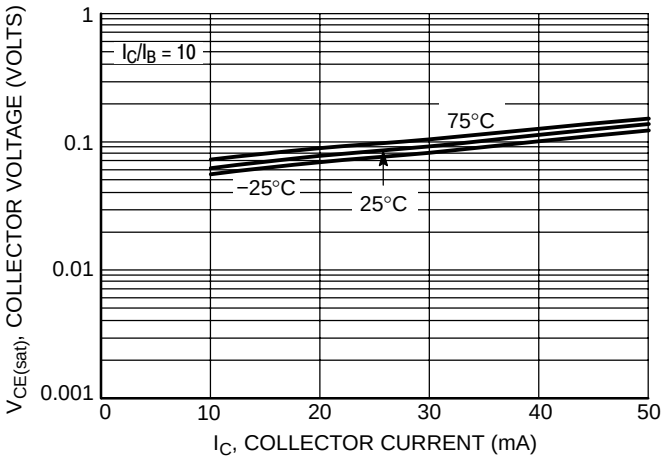


Figure 57. $V_{CE(sat)}$ versus I_C

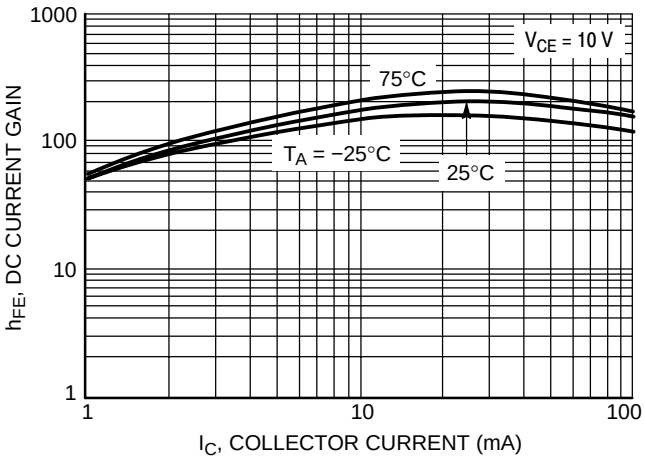


Figure 58. DC Current Gain

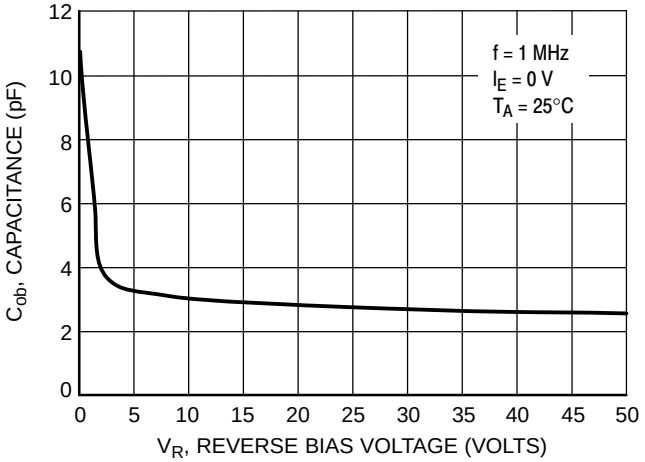


Figure 59. Output Capacitance

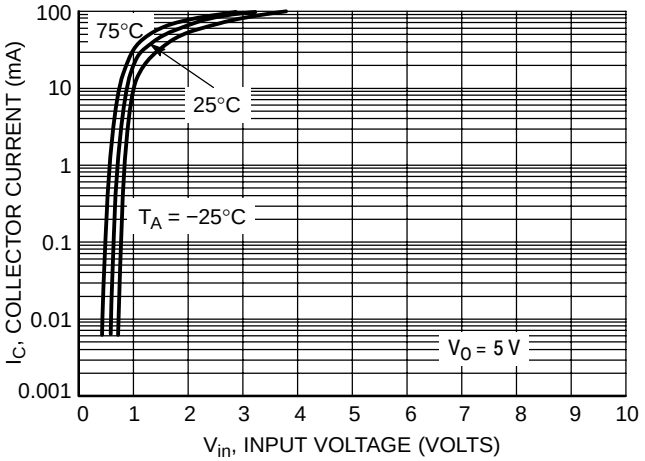


Figure 60. Output Current versus Input Voltage

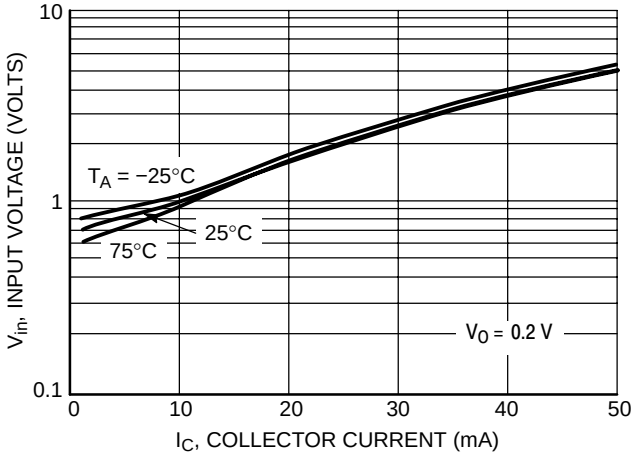


Figure 61. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5136DW1T1

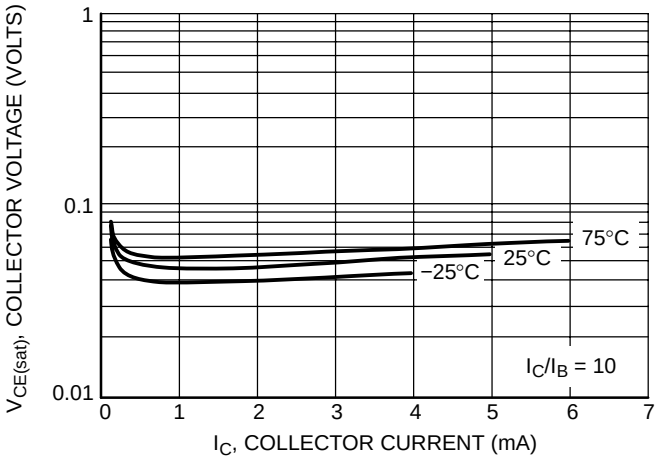


Figure 62. $V_{CE(sat)}$ versus I_C

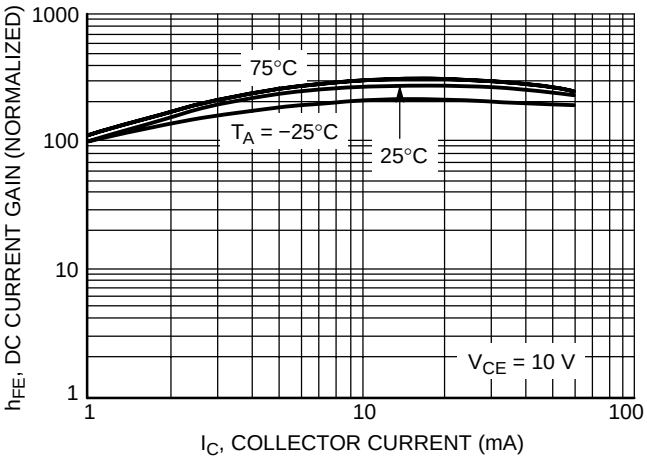


Figure 63. DC Current Gain

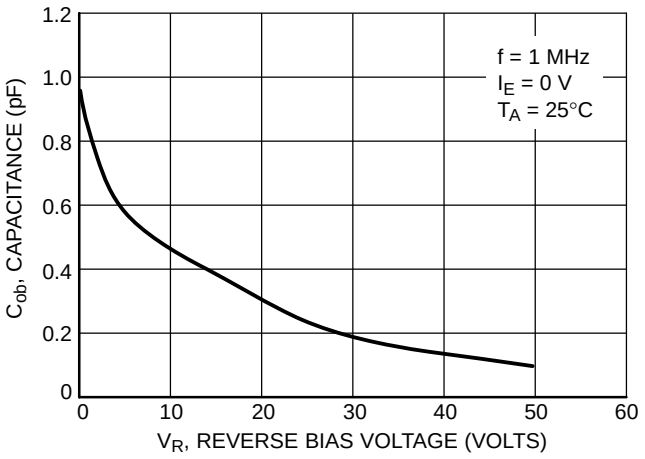


Figure 64. Output Capacitance

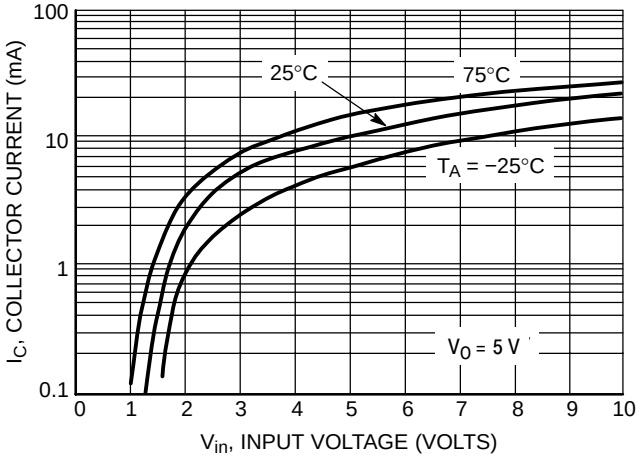


Figure 65. Output Current versus Input Voltage

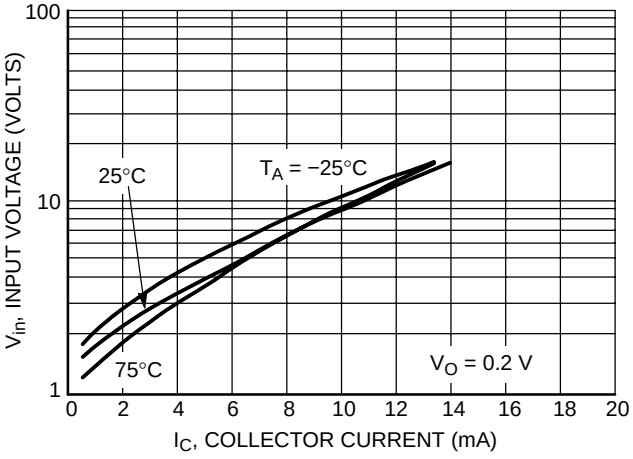


Figure 66. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — MUN5137DW1T1

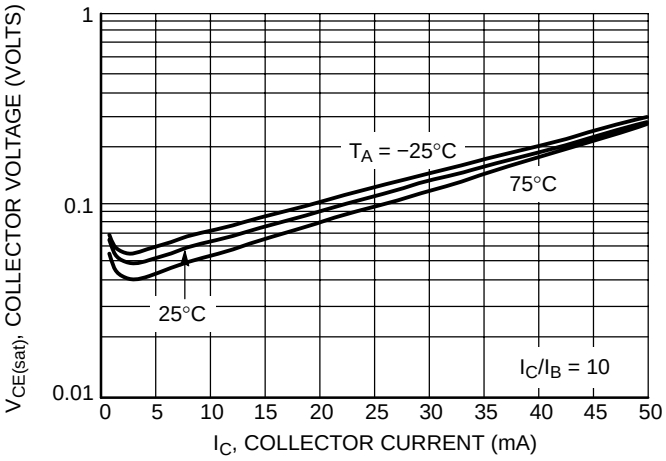


Figure 67. $V_{CE(sat)}$ versus I_C

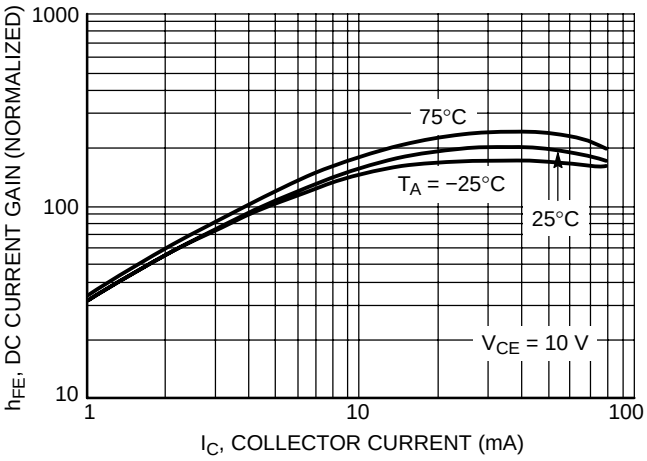


Figure 68. DC Current Gain

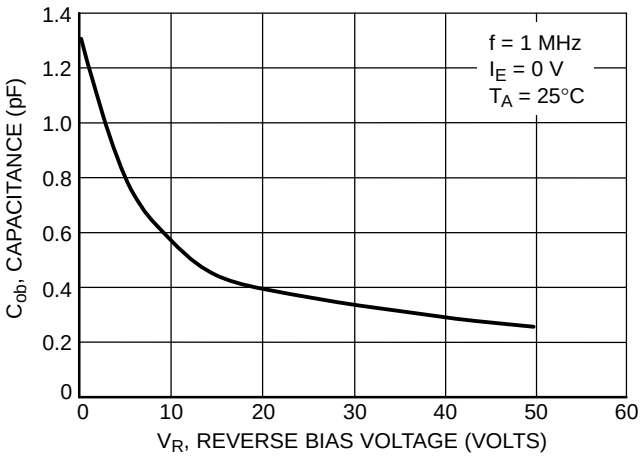


Figure 69. Output Capacitance

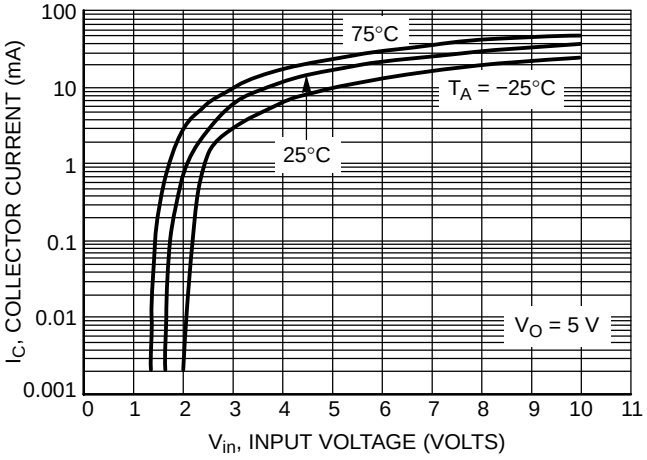


Figure 70. Output Current versus Input Voltage

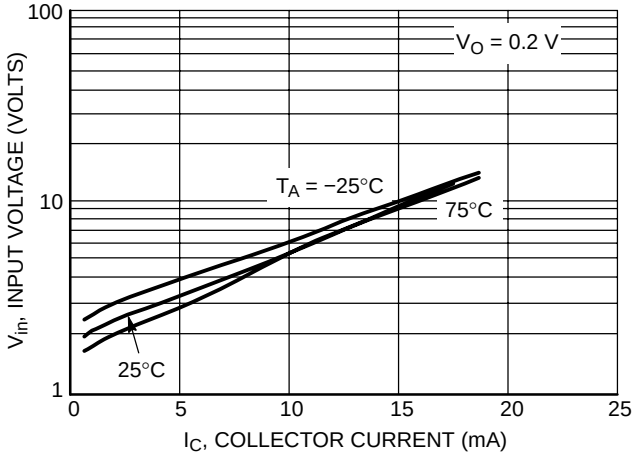
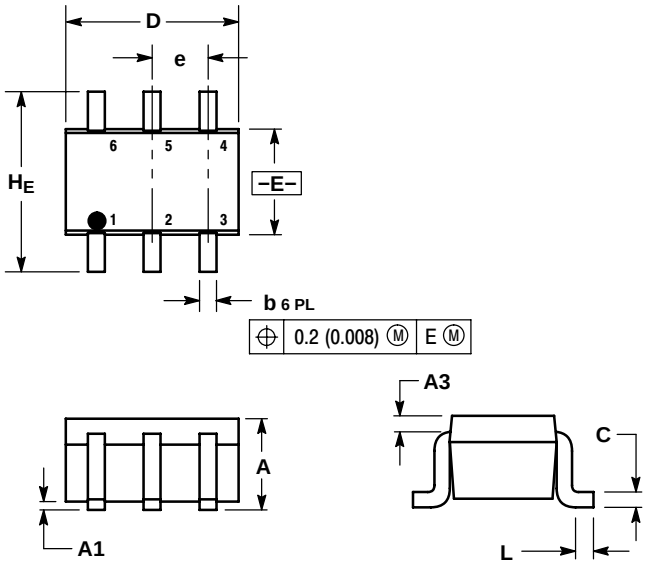


Figure 71. Input Voltage versus Output Current

PACKAGE DIMENSIONS

SC−88 (SOT−363)
CASE 419B−02
ISSUE V

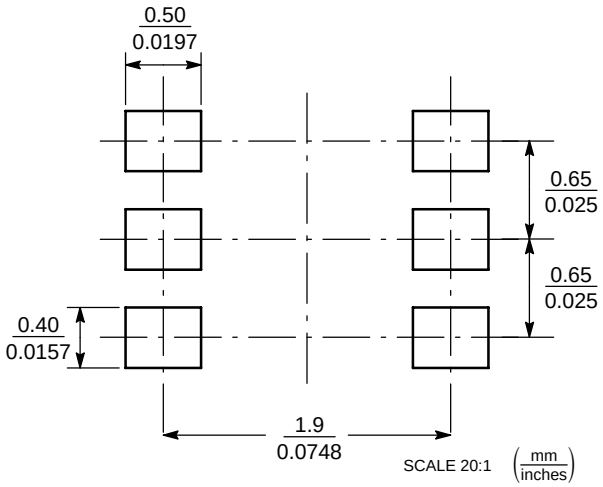


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B−01 OBSOLETE, NEW STANDARD 419B−02.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
C	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
H_E	2.00	2.10	2.20	0.078	0.082	0.086

STYLE 1:
PIN 1. EMITTER 2
2. BASE 2
3. COLLECTOR 1
4. EMITTER 1
5. BASE 1
6. COLLECTOR 2

SOLDERING FOOTPRINT*



*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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